

PRODUCT NUMBER

95609-XXXLF

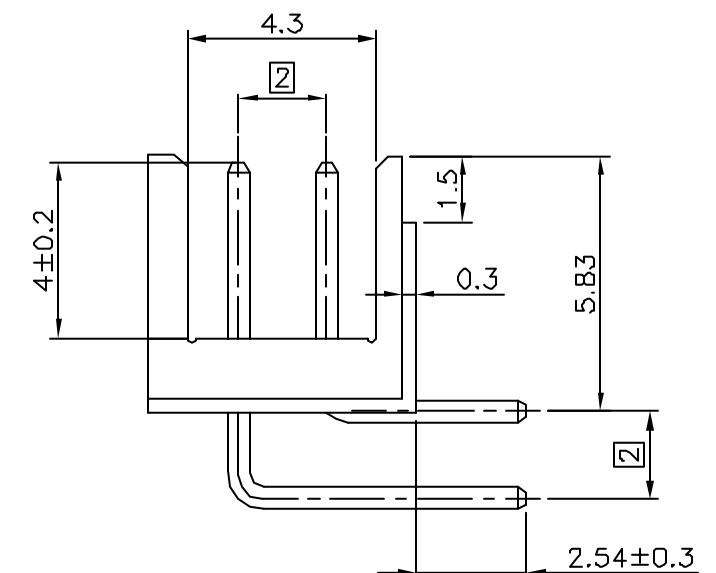
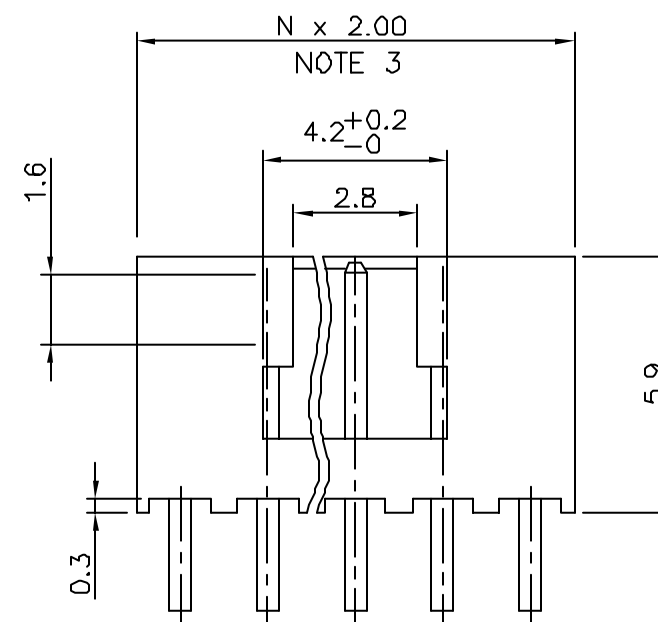
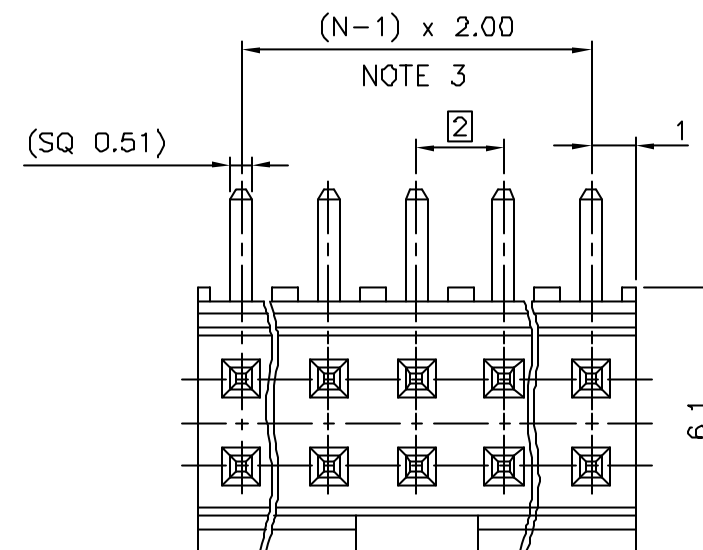
PLATING

- 0 = 0.20µm Au/GXT
- 1 = 0.76µm Au/GXT
- 3 = 0.38µm Au/GXT
- 5 = 0.38µm GXT
- 6 = 0.76µm GXT

UNDERPLATING 1.27µm Ni MIN

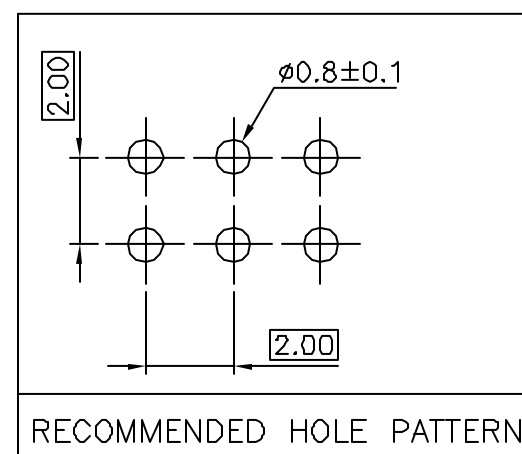
WHEN REQUIRED, ADD SUFFIX LETTER "LF"
INDICATES THE PRODUCT IS RoHS
COMPATIBLE, SEE NOTE 6 & 7

TOTAL NB OF POSITIONS, 08 TO 34



NOTES:

1. MATERIAL HOUSING: HIGH TEMP. THERMOPLASTIC
UL 94V-0, COLOR CREAM
2. MATERIAL TERMINAL: COPPER ALLOY
3. TO DETERMINE DIMENSIONS:
N = NUMBER OF POSITIONS PER ROW
4. 7N MIN. PIN RETENTION IN EITHER DIRECTION.
5. STANDARD PACKAGING IN POLYBAGS.
6. 95609-XXXLF IS SIMILAR TO 95609-XXX, THE SUFFIX "LF"
IS ADDED FOR EASY LEAD FREE IDENTIFICATION
7. RoHS COMPATIBLE PRODUCT SPECIFICATIONS
 - a - MANUFACTURING PROCESS COMPATIBILITY
 - THE HOUSING WILL WITHSTAND EXPOSURE TO
260°C ±5°C SOLDER BATH TEMPERATURE FOR
5 SECONDS IN A WAVE SOLDER APPLICATION
WITH A 1.6mm MIN THICK CIRCUIT BOARD.
 - b - LABELLING:
 - MEETS PACKAGING SPECS AS PER GS-14-920
 - c - THIS PRODUCT MEETS EUROPEAN DIRECTIVES
AND OTHER COUNTRY REGULATIONS AS DISCRIBED
IN GS-22-008.



mat'l. code				surface	tolerance	projection	product family		
SEE NOTES				ISO 1302	ISO 406	ISO 101	MINITEK HEADER		
ltr	ecn no	dr	date	tolerances unless otherwise specified			title		
C	F05-0128	LMU	05.02.21	angles	.X	±0.3	SHR HEADER 2.00mm TMT R/A		
D	F06-0210	LMU	06.07.04	linear	.XX	±0.13			
E	F08-0145	ELA	15.04.08	±2°	.XXX	±0.05			
				dr	L.MULIN	02.06.19	FCI		
				engr	J.COMPAGNON	02.06.19			
				chr					
				appd	JMC	02.06.19	type CUSTOMER Drawing		
				sheet index	revision sheet				